IAP20 Rec'd PCT/PTO 04 MAY 2006

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

Washio et al.

Appl. No.

U.S. National Phase of

PCT/JP2004/017534

Filed

Herewith

For

THICK FILM PHOTORESIST

COMPOSITION AND METHOD OF FORMING RESIST PATTERN

Examiner

Unassigned

Group Art Unit

Unknown

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

May 4, 2006

Neil S. Barifeld Ph.D., Reg. No. 39,90

PRELIMINARY AMENDMENT

Mail Stop PCT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Prior to examination of the above-referenced application, please enter the following amendments:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims begin on page 3 of this paper.

Remarks begin on page 5 of this paper.